

Type	Hits	Search Text	DBs	Time Stamp
1 BRS	8	(semiconductor near5 laser) and substrate and (optic\$3 near3 (fiber or waveguide)) and ((plastic or thermoplast or duroplast) near5 body) and (coolant or water) and lens and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 09:20
2 BRS	0	(semiconductor near5 laser) and (substrate near8 lead) and (optic\$3 near3 (fiber or waveguide)) and ((thermoplast or duroplast) near5 body) and ((heat or thermal) near8 (microchannel or microplate or micropore)) and (coolant or water) and (len near5 cylind\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 08:45
3 BRS	0	(semiconductor near5 laser) and (substrate near6 metal) and (optic\$3 near3 (fiber or waveguide)) and ((thermoplast or duroplast) near5 body) and ((heat or thermal) near8 (microchannel or microplate or micropore)) and (coolant or water) and (len near5 cylind\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 08:57
4 BRS	0	(semiconductor near5 laser) and (substrate) and (optic\$3 near3 (fiber or waveguide)) and ((thermoplast or duroplast) near6 (housing or casing or protect\$4 or body)) and ((heat or thermal) near8 (microchannel or microplate or micropore)) and (coolant or water) and (len near5 cylind\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 09:00
5 BRS	0	(semiconductor near5 laser) and (substrate) and (optic\$3 near3 (fiber or waveguide)) and ((thermoplast or duroplast) near6 (housing or casing or protect\$4 or body)) and (coolant or water) and (len near5 cylind\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 09:00
6 BRS	0	(semiconductor near5 laser) and (substrate) and (optic\$3 near3 (fiber or waveguide)) and (plastic near6 (housing or casing or protect\$4 or body)) and ((heat or thermal) near8 (microchannel or microplate or micropore)) and (coolant or water) and (len near5 cylind\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 09:01

Type	Hits	Search Text	DBs	Time Stamp
7 BRS	4	(semiconductor near5 laser) and (substrate) and (optic\$3 near3 (fiber or waveguide)) and (plastic near6 (housing or casing or protect\$4 or body)) and (coolant or water) and (len near5 cylind\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 09:04
8 BRS	16	(5668903, 5548605, 5516727, 5327443, 5309460, 5307362, "5218611").pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 09:26
9 BRS	4	(5311535, "5526373").pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 09:27
10 BRS	95	(thermoplast or duroplast) and resin and glass and opaque	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 16:00
11 BRS	7	((thermoplast or duroplast) and resin and glass and opaque) and (semiconductor fill\$3) and opaque	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 15:59
12 BRS	143	((thermoplast or duroplast) and (glass or fill\$3) and opaque) and (semiconductor near6 (laser or diode))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 16:01
13 BRS	1	(semiconductor near5 laser) and substrate and (optic\$3 near3 (fiber or waveguide)) and (coat\$4 near6 silic\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 16:01
14 BRS	344	(semiconductor near5 laser) and substrate and (optic\$3 near3 (fiber or waveguide)) and (coat\$4 near6 silic\$4) and (cross near4 area)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 09:22
15 BRS	39	(semiconductor near5 laser) and substrate and ((optic\$3 near3 (fiber or waveguide)) and (near8 (coat\$4 near6 silic\$4)) and (cross near4 area))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 09:50
16 BRS	0	(semiconductor near5 laser) and substrate and ((optic\$3 near3 (fiber or waveguide)) near10 (coat\$4 near6 silic\$4)) and (cross near4 area)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:02
17 BRS	0		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:08

Type	Hits	Search Text	DBs	Time Stamp
18 BRS 0	(semiconductor near5 laser) and ((optic\$3 near3 (fiber or waveguide)) near10 (coat\$4 near4 (silic\$4)) and polish\$3 and ((cross\$4 or cross\$1 section\$3) near6 area))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:13	
19 BRS 4362	(semiconductor near5 laser) and (len near4 cylind\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:13	
20 BRS 293	(semiconductor near5 laser) and (len near4 cylind\$6) and (optic\$3 near3 waveguide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:14	
21 BRS 8	(semiconductor near5 laser) and (len near4 cylind\$6) and ((optic\$3 near3 waveguide) near silic\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:21	
22 BRS 0	(semiconductor near5 laser) and (len near4 cylind\$6) and ((optic\$3 near3 waveguide) near6 silic\$6 near6 polish\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:37	
23 BRS 4	(semiconductor near5 laser) and ((optic\$3 near3 waveguide) near6 silic\$6 near6 polish\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:40	
24 BRS 4	(semiconductor near5 laser) and ((optic\$3 near3 waveguide) near6 (coat\$4 near4 silic\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:42	
25 BRS 0	(semiconductor near5 laser) and ((optic\$3 near3 waveguide) near8 (polish\$4 near18 (advantage or benefit)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 14:20	
26 BRS 5	((optic\$3 near3 waveguide) near8 (polish\$4 near18 (advantage or benefit)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 10:54	
27 BRS 2	5268978.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 11:09	
28 BRS 3	(semiconductor near5 laser) and ((optic\$3 near3 waveguide) near8 ((silicon near3 dioxide) near6 coat\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 14:22	
29 BRS 0	(semiconductor near5 laser) and ((optic\$3 near3 waveguide) near8 ((silicon near3 dioxide) near6 coat\$4)) and slant and polish	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 14:38	

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30 BRS	0	((optic\$3 near3 waveguide) near8 ((silicon near3 dioxide) near6 coat\$4)) and slant and polish	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 14:40
31 BRS	0	((optic\$3 near3 waveguide) near8 ((silic\$3) near6 coat\$4)) and slant and polish	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 14:41
32 BRS	0	((optic\$3 near3 waveguide) near8 ((silic\$3) near6 coat\$4)) and polish	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 15:21
33 BRS	1	laser and ((optic\$3 near3 (fiber or waveguide) near8 (coat\$4)) and slant and polish	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 15:23
34 BRS	610	385/94	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:28
35 BRS	537	385/38	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:28
36 BRS	849	437/211	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:28
37 BRS	2139	372/6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:28
38 BRS	1198	372/36	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:28
39 BRS	3079	372/50	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:29
40 BRS	915	385/93	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:29
41 BRS	1453	385/92	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:29
42 BRS	463	385/91	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/15 16:29